

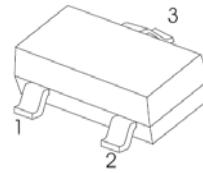
## General Description

The AO3480 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . This device is suitable for use as a load switch or in PWM applications.

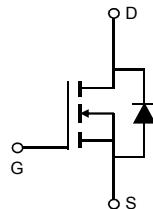
## Product Summary

|                                    |          |
|------------------------------------|----------|
| $V_{DS}$                           | 30V      |
| $I_D$ (at $V_{GS}=10V$ )           | 5.7A     |
| $R_{DS(ON)}$ (at $V_{GS}=10V$ )    | < 26.5mΩ |
| $R_{DS(ON)}$ (at $V_{GS} = 4.5V$ ) | < 32mΩ   |
| $R_{DS(ON)}$ (at $V_{GS} = 2.5V$ ) | < 50mΩ   |

SOT - 23



1. GATE
2. SOURCE
3. DRAIN



Absolute Maximum Ratings  $T_A=25^\circ C$  unless otherwise noted

| Parameter                              | Symbol         | Maximum    | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage                   | $V_{DS}$       | 30         | V     |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 12$   | V     |
| Continuous Drain Current               | $I_D$          | 5.7        | A     |
| $T_A=70^\circ C$                       | $I_D$          | 4.7        |       |
| Pulsed Drain Current <sup>C</sup>      | $I_{DM}$       | 30         |       |
| Power Dissipation <sup>B</sup>         | $P_D$          | 1.4        | W     |
| $T_A=70^\circ C$                       | $P_D$          | 0.9        |       |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150 | °C    |

Thermal Characteristics

| Parameter   | Symbol          | Typ             | Max | Units |
|---|-----------------|-----------------|-----|-------|
| Maximum Junction-to-Ambient <sup>A</sup>                | $R_{\theta JA}$ | 70              | 90  | °C/W  |
| Maximum Junction-to-Ambient <sup>A,D</sup> Steady-State |                 | 100             | 125 | °C/W  |
| Maximum Junction-to-Lead                                | Steady-State    | $R_{\theta JL}$ | 63  | °C/W  |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions  | Min  | Typ  | Max    | Units            |
|-----------------------------|---------------------------------------|---|------|------|--------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |   |      |      |        |                  |
| $\text{BV}_{\text{DSS}}$    | Drain-Source Breakdown Voltage        | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$  | 30   |      |        | V                |
| $I_{\text{DSS}}$            | Zero Gate Voltage Drain Current       | $V_{DS}=30\text{V}, V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$               |      |      | 1<br>5 | $\mu\text{A}$    |
| $I_{\text{GSS}}$            | Gate-Body leakage current             | $V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$                                     |      |      | 100    | nA               |
| $V_{\text{GS(th)}}$         | Gate Threshold Voltage                | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$   | 0.65 | 1.05 | 1.45   | V                |
| $I_{\text{D(ON)}}$          | On state drain current                | $V_{GS}=4.5\text{V}, V_{DS}=5\text{V}$  | 30   |      |        | A                |
| $R_{\text{DS(ON)}}$         | Static Drain-Source On-Resistance     | $V_{GS}=10\text{V}, I_D=5.7\text{A}$  |      | 18   | 26.5   | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=4.5\text{V}, I_D=5\text{A}$   |      | 19   | 32     | $\text{m}\Omega$ |
|                             |                                       | $V_{GS}=2.5\text{V}, I_D=3\text{A}$   |      | 24   | 50     | $\text{m}\Omega$ |
| $g_{\text{FS}}$             | Forward Transconductance              | $V_{DS}=5\text{V}, I_D=5.7\text{A}$   |      | 33   |        | S                |
| $V_{\text{SD}}$             | Diode Forward Voltage                 | $I_S=1\text{A}, V_{GS}=0\text{V}$   |      | 0.7  | 1      | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |   |      |      | 2      | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |   |      |      |        |                  |
| $C_{\text{iss}}$            | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$                          |      | 630  |        | $\text{pF}$      |
| $C_{\text{oss}}$            | Output Capacitance                    |   |      | 75   |        | $\text{pF}$      |
| $C_{\text{rss}}$            | Reverse Transfer Capacitance          |   |      | 50   |        | $\text{pF}$      |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                           | 1.5  | 3    | 4.5    | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |   |      |      |        |                  |
| $Q_g$                       | Total Gate Charge                     | $V_{GS}=4.5\text{V}, V_{DS}=15\text{V}, I_D=5.7\text{A}$                      |      | 6    | 10     | $\text{nC}$      |
| $Q_{\text{gs}}$             | Gate Source Charge                    |   |      | 1.3  |        | $\text{nC}$      |
| $Q_{\text{gd}}$             | Gate Drain Charge                     |   |      | 1.8  |        | $\text{nC}$      |
| $t_{\text{D(on)}}$          | Turn-On Delay Time                    | $V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=2.6\Omega, R_{\text{GEN}}=3\Omega$ |      | 3    |        | ns               |
| $t_r$                       | Turn-On Rise Time                     |   |      | 2.5  |        | ns               |
| $t_{\text{D(off)}}$         | Turn-Off Delay Time                   |   |      | 25   |        | ns               |
| $t_f$                       | Turn-Off Fall Time                    |   |      | 4    |        | ns               |
| $t_{\text{rr}}$             | Body Diode Reverse Recovery Time      | $I_F=5.7\text{A}, dI/dt=100\text{A}/\mu\text{s}$                              |      | 8.5  |        | ns               |
| $Q_{\text{rr}}$             | Body Diode Reverse Recovery Charge    | $I_F=5.7\text{A}, dI/dt=100\text{A}/\mu\text{s}$                              |      | 2.6  |        | $\text{nC}$      |

A. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{C}$ , using  $\leq 10\text{s}$  junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .

D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{C}$ . The SOA curve provides a single pulse rating.

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

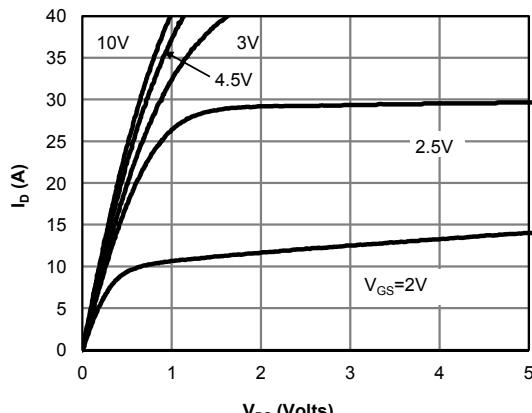


Fig 1: On-Region Characteristics (Note E)

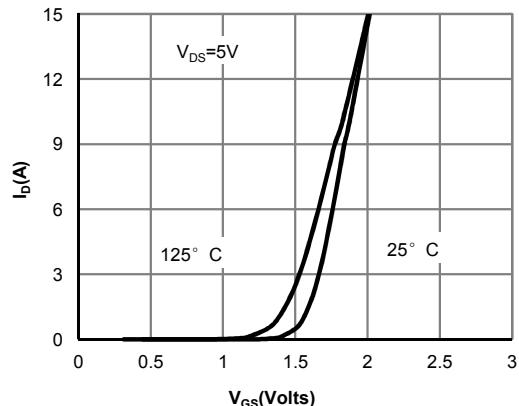


Figure 2: Transfer Characteristics (Note E)

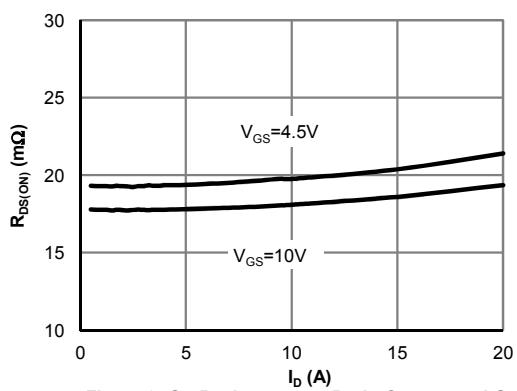


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

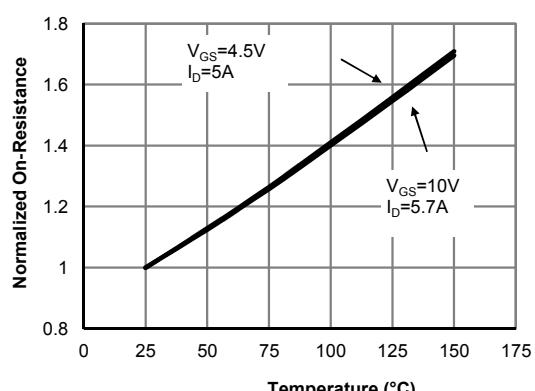


Figure 4: On-Resistance vs. Junction Temperature (Note E)

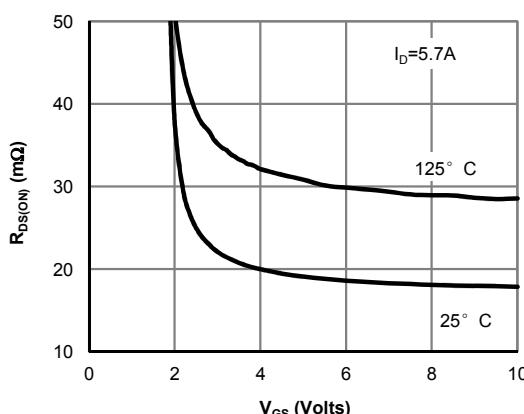


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

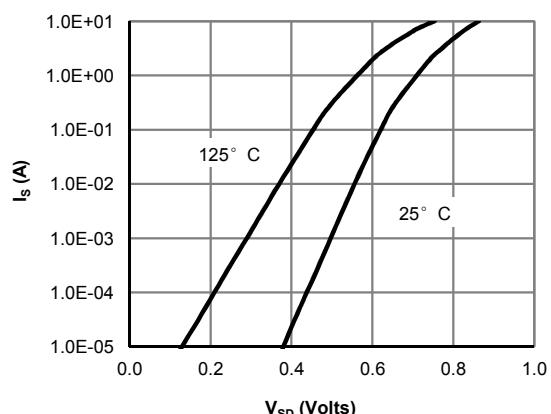


Figure 6: Body-Diode Characteristics (Note E)

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

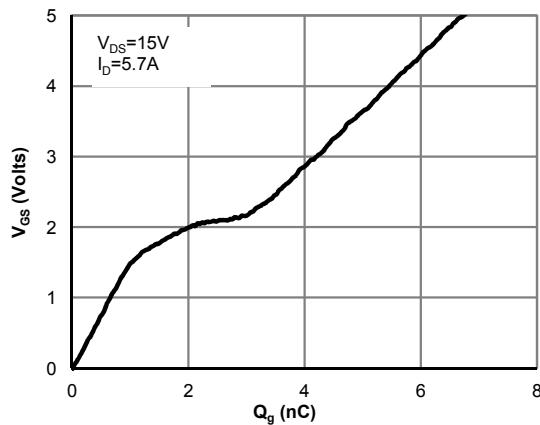


Figure 7: Gate-Charge Characteristics

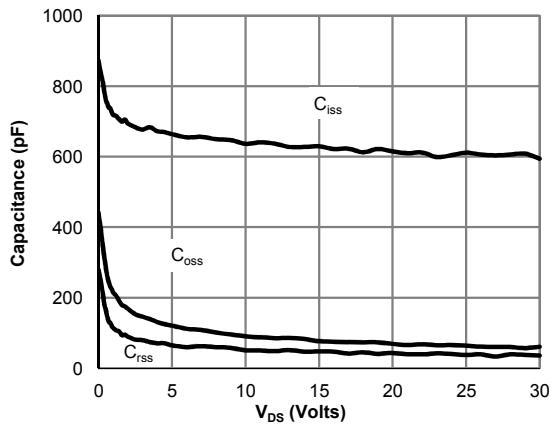


Figure 8: Capacitance Characteristics

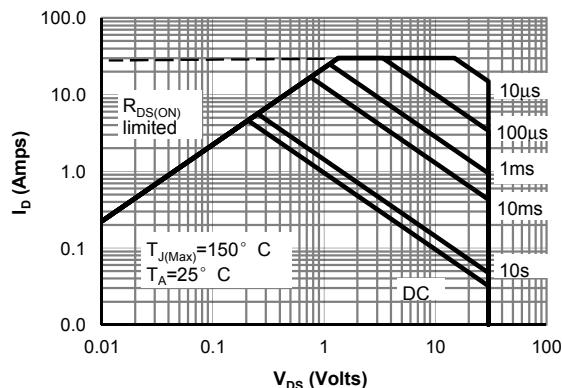


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

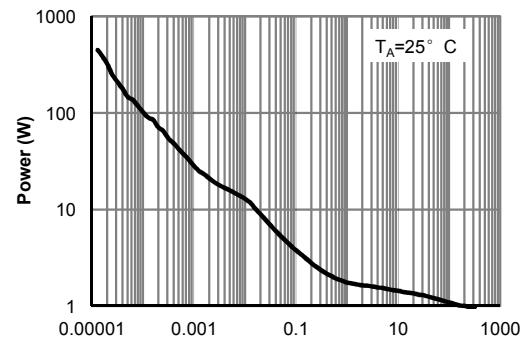
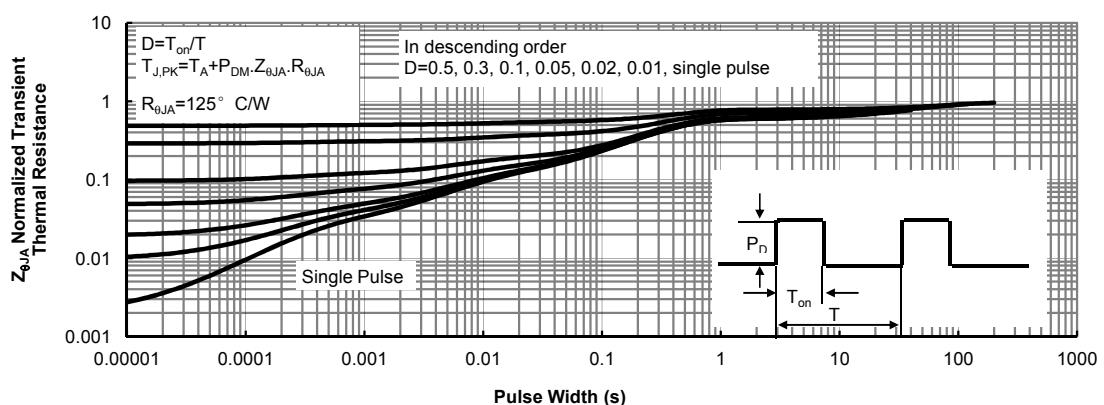
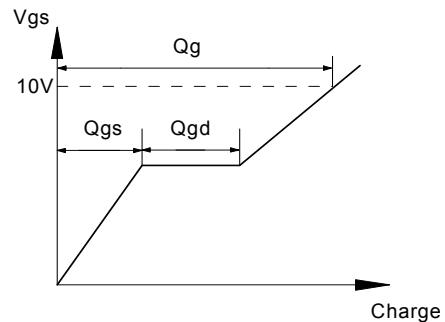
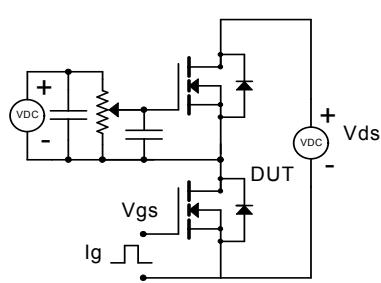


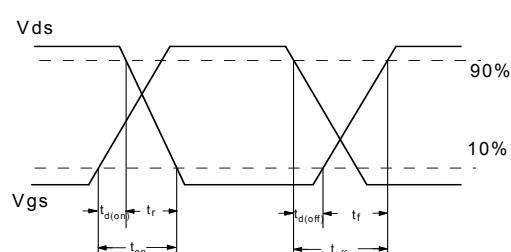
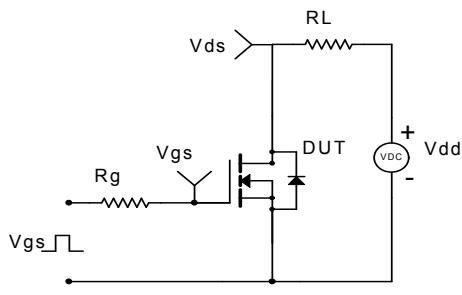
Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)



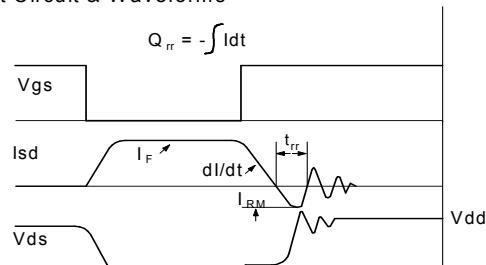
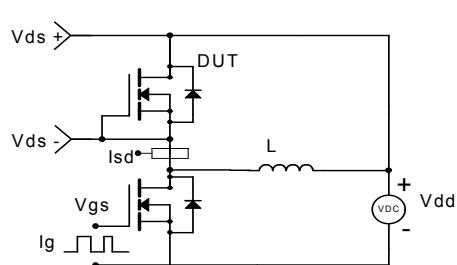
Gate Charge Test Circuit & Waveform



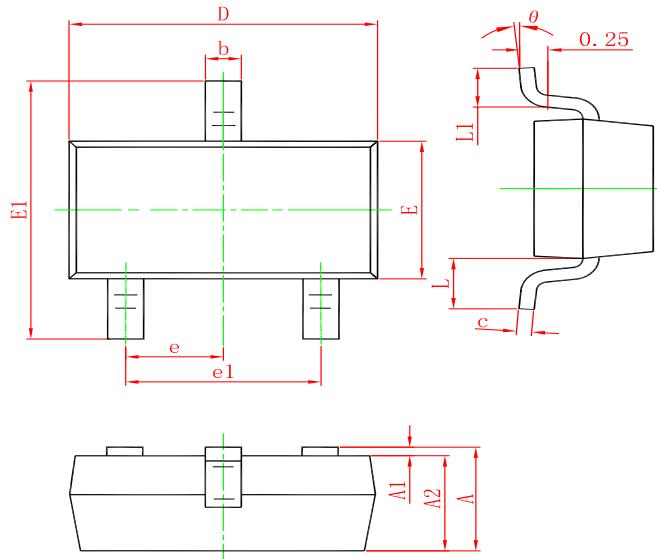
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

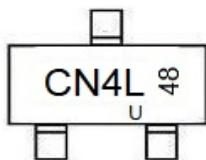


## SOT-23 PACKAGE OUTLINE DIMENSIONS



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.150 | 0.035                | 0.045 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 0.900                     | 1.050 | 0.035                | 0.041 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.080                     | 0.150 | 0.003                | 0.006 |
| D      | 2.800                     | 3.000 | 0.110                | 0.118 |
| E      | 1.200                     | 1.400 | 0.047                | 0.055 |
| E1     | 2.250                     | 2.550 | 0.089                | 0.100 |
| e      | 0.950 TYP.                |       | 0.037 TYP.           |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.550 REF.                |       | 0.022 REF.           |       |
| L1     | 0.300                     | 0.500 | 0.012                | 0.020 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

## Marking



## Ordering information

| Order code  | Package | Baseqty | Deliverymode  |
|-------------|---------|---------|---------------|
| UMW AO3480A | SOT-23  | 3000    | Tape and reel |

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